

## Features and Application

- 500-mA Rated Collector Current (Single Output)
- High-Voltage Outputs . . . 50 V
- Output Clamp Diodes
- Inputs Compatible With Various Types of Logic
- Relay Driver Applications

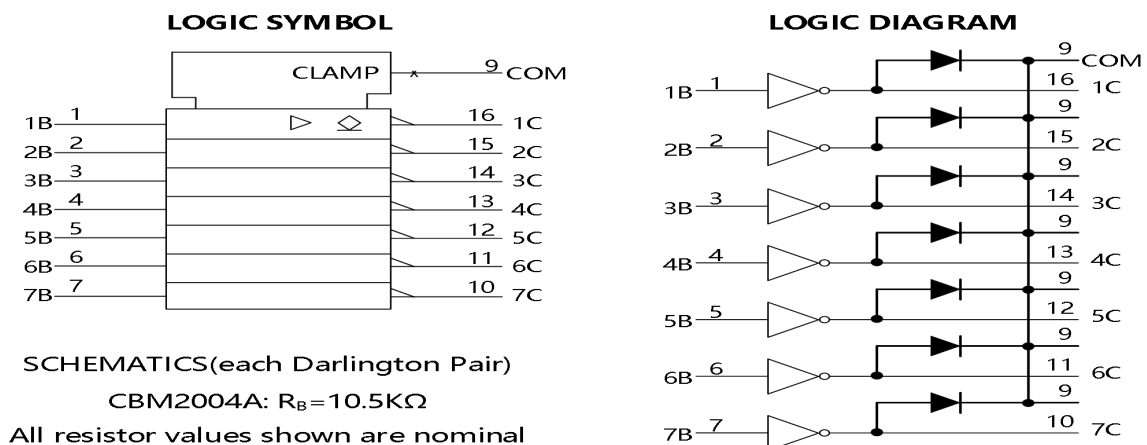
## Description

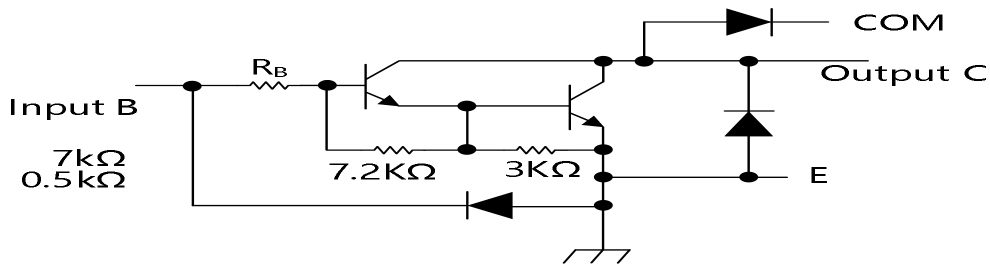
The CBM2004A are monolithic high-voltage, high-current Darlington transistor arrays. Each consists of seven n-p-n Darlington pairs that feature high-voltage outputs with common-cathode clamp diodes for switching inductive loads.

The collector-current rating of a single Darlington pair is 500 mA.

The Darlington pairs may be paralleled for higher current capability. Applications include relay drivers, hammer drivers, lamp drivers, display drivers (LED and gas discharge), line drivers, and logic buffers.

The CBM2004A has a 10.5kΩ series base resistor for each Darlington pair for operation directly with 6-15V CMOS devices.

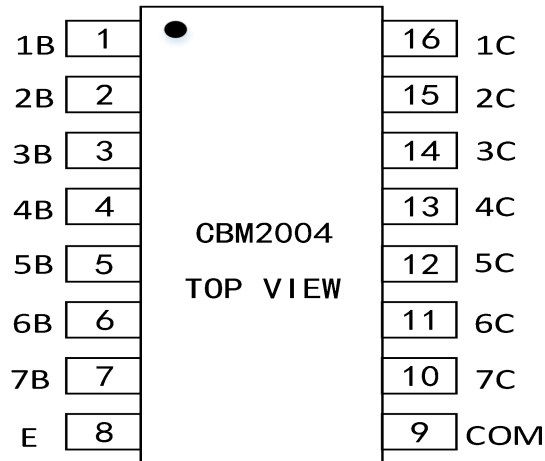




## CATALOG

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## Pin Configuration



## Pin Description

Pin Num	Symbol	I/O	Pin Description
1	1B	I	Channel 1 through 7 Darlington base input
t	2B		
3	3B		
4	4B		
5	5B		
6	6B		
7	7B		
16	1C	O	Channel 1 through 7 Darlington collector output
15	2C		
14	3C		
13	4C		
12	5C		
11	6C		
10	7C		
9	COM	--	Common cathode node for flyback diodes (required for inductive loads)
8	E	--	Common emitter shared by all channels (typically tied to ground)

## Absolute Maximum Ratings ( $T_A = 25^\circ\text{C}$ )

Parameter	Symbol	Values	Unit
Collector-emitter voltage		50	V
Input voltage(see Note 1)	$V_I$	30	V
Peak collector current (see Figures 14 and 15)		500	mA
Output clamp current	$I_{OK}$	500	mA
Total emitter-terminal current		-2.5	A
Continuous total power dissipation		See Dissipation Rating Table	
Operating free-air temperature range	$T_A$	-40 to 85	$^\circ\text{C}$
Storage temperature range	$T_{STG}$	-55 to 150	$^\circ\text{C}$
Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds		260	$^\circ\text{C}$

**NOTE 1:** All voltage values are with respect to the emitter/substrate terminal E, unless otherwise noted.

## Dissipation Rating Table

PACKAGE	$T_A=25^\circ\text{C}$ POWER RATING	DERATING FACTOR above $T_A=25^\circ\text{C}$	$T_A=85^\circ\text{C}$ POWER RATING
D	1210mW	7.6mW/ $^\circ\text{C}$	494mW
N	1420mW	9.2mW/ $^\circ\text{C}$	598mW

## Electrical Characteristics ( $T_A = 25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	Test Fig.	Test Conditions	Min	Typ	Max	Unit
$V_{i(on)}$	Input Voltage	6	$V_{CE}=2V$ $I_C = 125mA$ $I_C = 200mA$ $I_C = 275mA$ $I_C = 350mA$			5 6 7 8	V
$V_{CE(sat)}$	Collector-emitter Saturation Voltage	5	$I_C = 100mA$ $I_B = 250mA$ $I_C = 200mA$ $I_B = 350mA$ $I_C = 350mA$ $I_B = 500mA$		0.9 1.1 1.3	1.1 1.3 1.6	V
ICEX	Output Leakage Current	2	$V_{CE} = 50V, V_i = 1V$			500	$\mu A$
$V_F$	Clamp Diode Forward Voltage	8	$I_F = 350mA$		1.7	2	V
$I_i(off)$	Off-state Input Current	3	$V_{CE}=50V, T_{AMB} = 70^\circ\text{C},$ $I_C = 500mA$	50	65		$\mu A$
$I_i$	Input Current	4	$V_i = 5V, V_i = 12V$		0.35 1	0.5 1.45	mA
$I_R$	Clamp Reverse Current	7	$V_R = 50V$ $T_{AMB} = 70^\circ\text{C}, V_R = 50V$			50 100	$\mu A$
$C_i$	Input Capacitance				15	25	pF
<b>Switching Characteristics, <math>T_A=25^\circ\text{C}</math></b>							
$T_{PLH}$	Turn-on Delay Time		See Fig.9		0.25	1	$\mu s$
$T_{PHL}$	Turn-off Delay Time		See Fig.9		0.25	1	$\mu s$
$V_{OH}$	High level output voltage after switching		$V_S=50V, I_O=300mA$ See Fig.10	$V_S-20$			mV

## Parameter Measurement Information

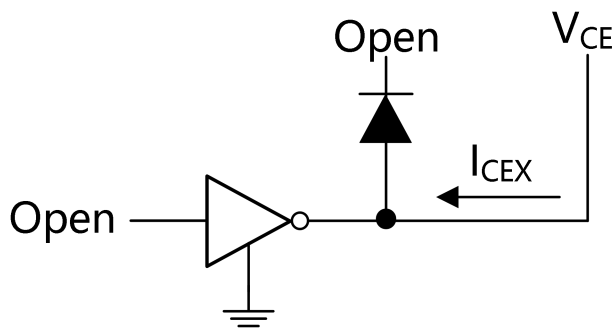


Figure 1 .  $I_{CEX}$  Test Circuit

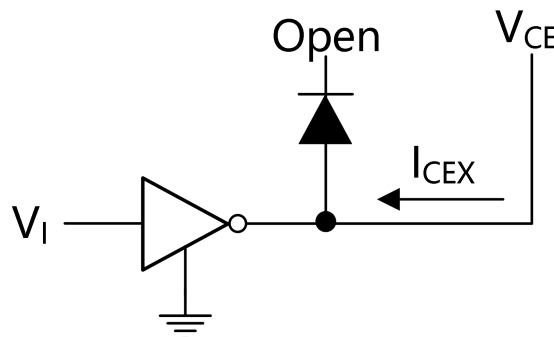


Figure 2 .  $I_{CEX}$  Test Circuit

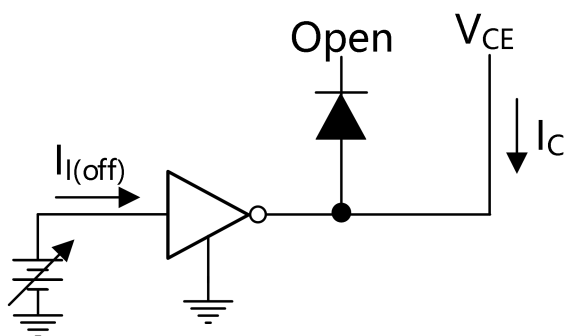


Figure 3 .  $I_{I(off)}$  Test Circuit

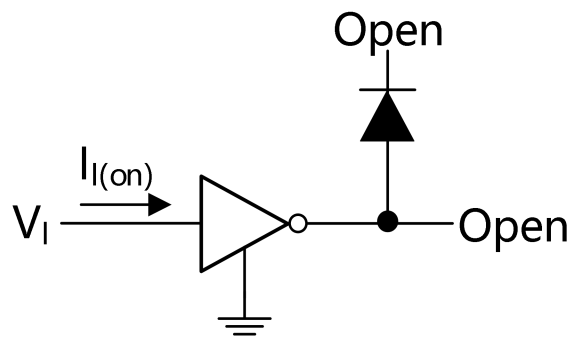
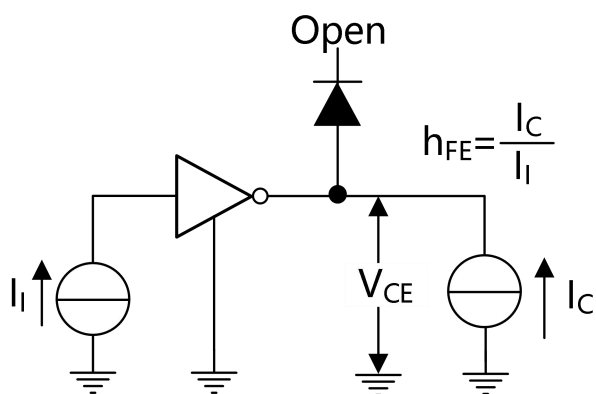


Figure 4 .  $I_I$  Test Circuit



Note: $I_I$  is fixed for measuring  $V_{CE(sat)}$ , Variable or measuring  $h_{FE}$

Figure 5 .  $H_{FE} V_{CE}$  Test Circuit

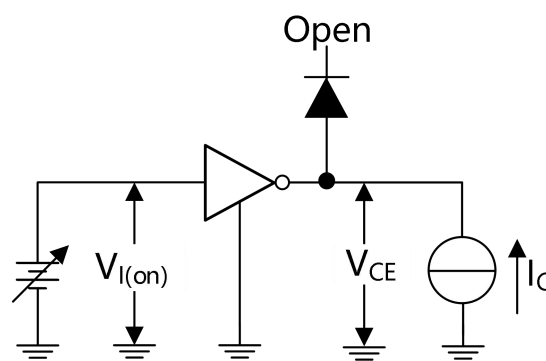


Figure 6 .  $V_{I(on)}$  Test Circuit

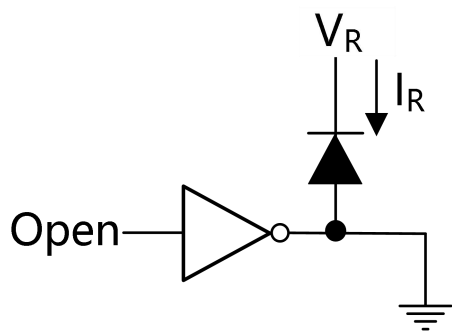


Figure 7 .  $I_R$  Test Circuit

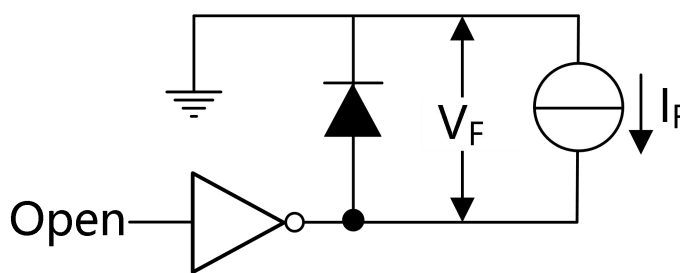
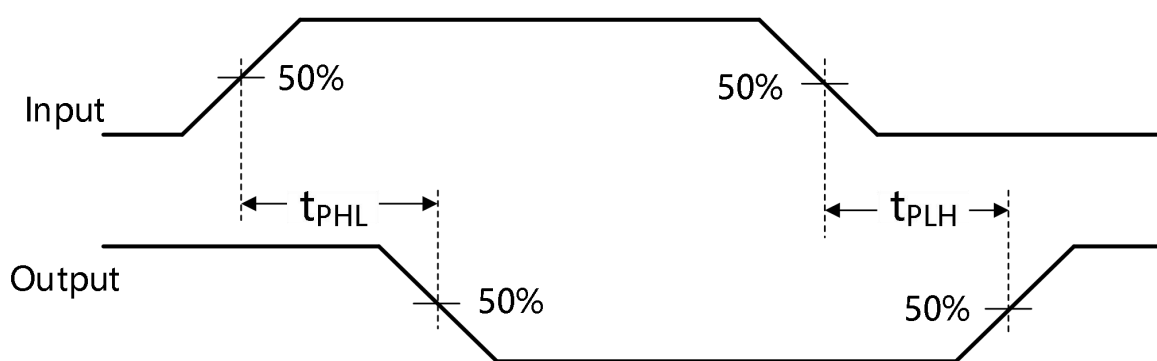
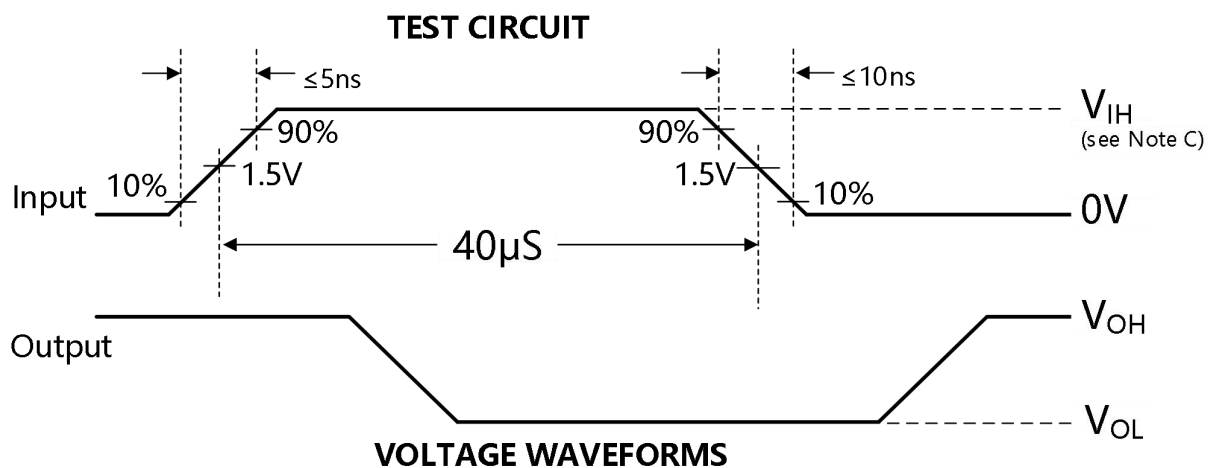


Figure 8 .  $V_F$  Test Circuit



**VOLTAGE WAVEFORMS**

Figure 9. Propagation Delay-Time Waveforms



**VOLTAGE WAVEFORMS**

Figure 10. Latch-Up Test Circuit and Voltage Waveforms

**NOTES:**

- A. The pulse generator has the following characteristics: PRR = 12.5 kHz,  $Z_0=50$ .
- B. CL includes probe and jig capacitance.
- C.  $V_{IH} = 12V$ .

## Typical Characteristics

COLLECTOR-EMITTER  
SATURATION VOLTAGE  
VS  
COLLECTOR CURRENT  
(ONE DARLINGTON)

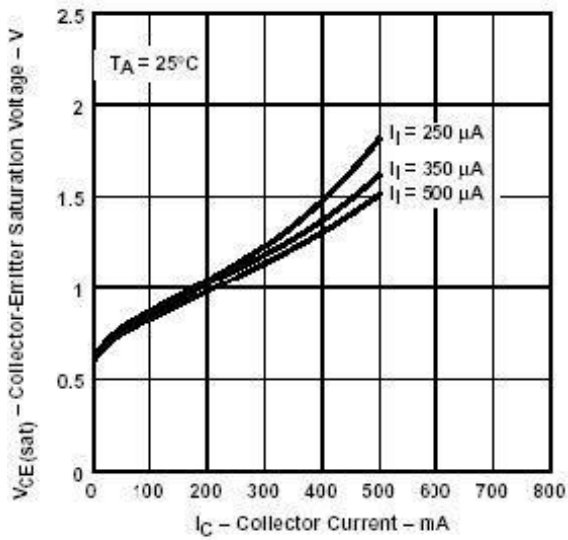


Figure 11

Figure 11

COLLECTOR-EMITTER  
SATURATION VOLTAGE  
VS  
TOTAL COLLECTOR CURRENT  
TWO DARLINGTONS PARALLELED

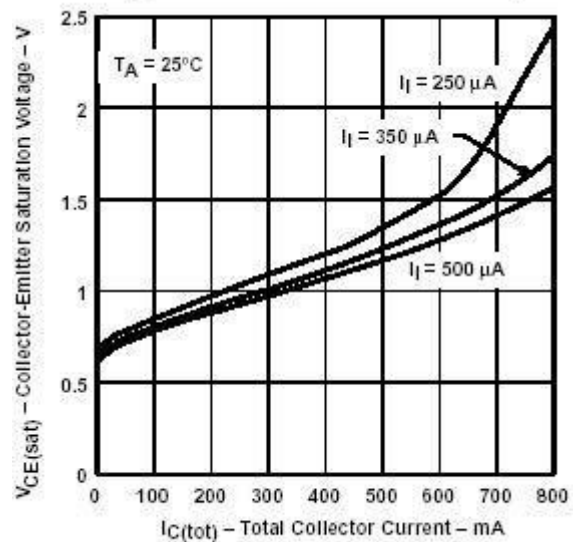


Figure 12

Figure 12

COLLECTOR CURRENT  
VS  
INPUT CURRENT

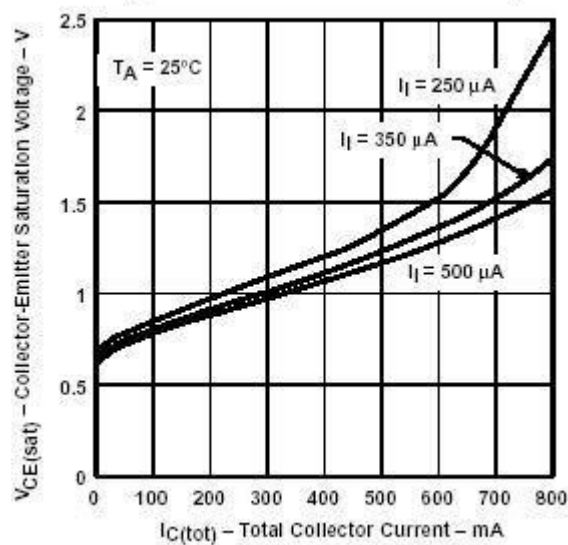


Figure 12

Figure 13



## Thermal Information

D PACKAGE  
MAXIMUM COLLECTOR CURRENT  
VS  
DUTY CYCLE

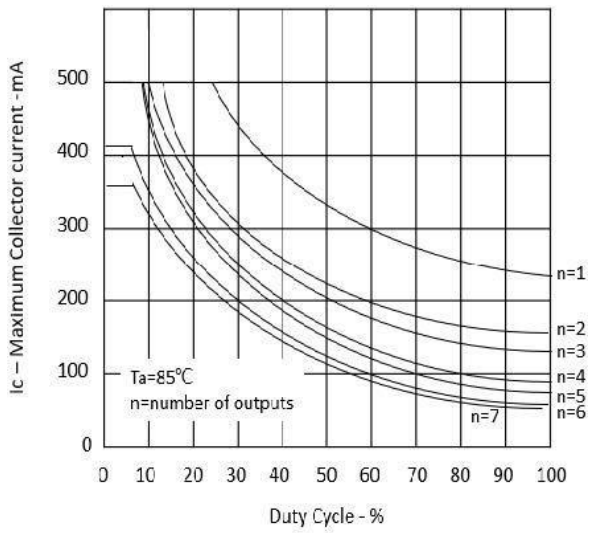


Figure 14

N PACKAGE  
MAXIMUM COLLECTOR CURRENT  
VS  
DUTY CYCLE

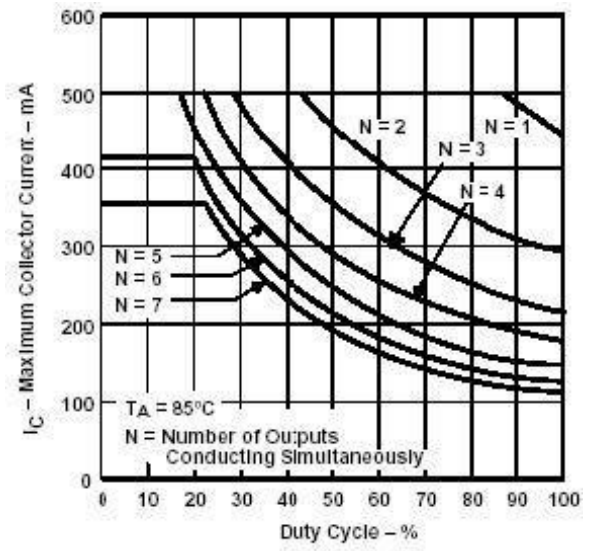


Figure 15

## Application Information

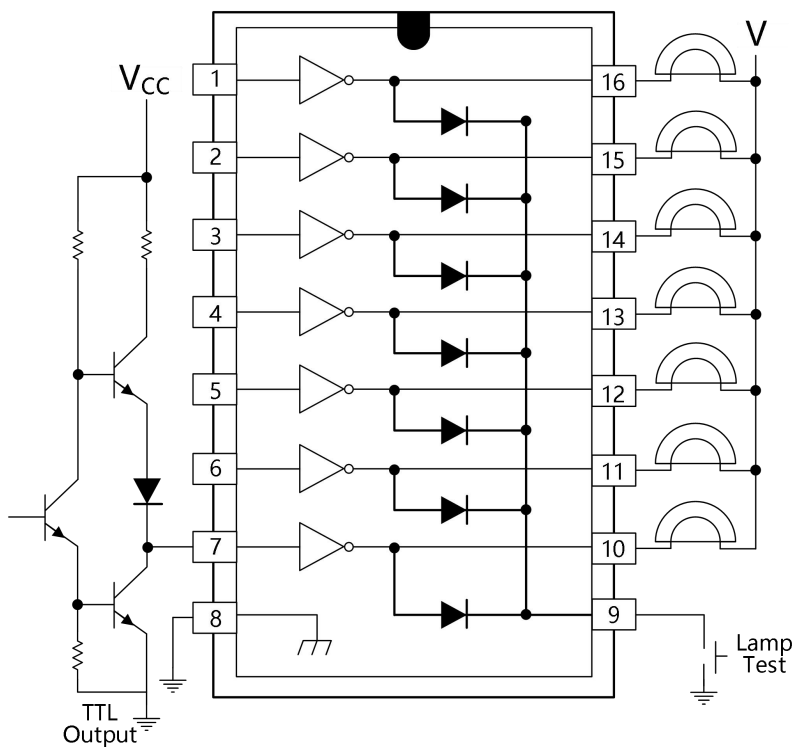


Figure 16. TTL to Load

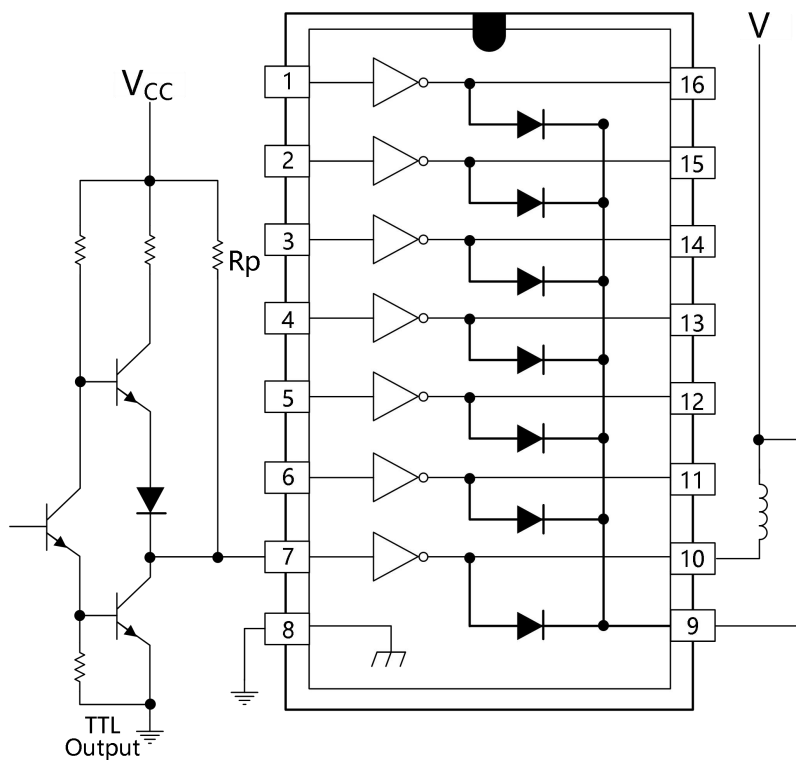
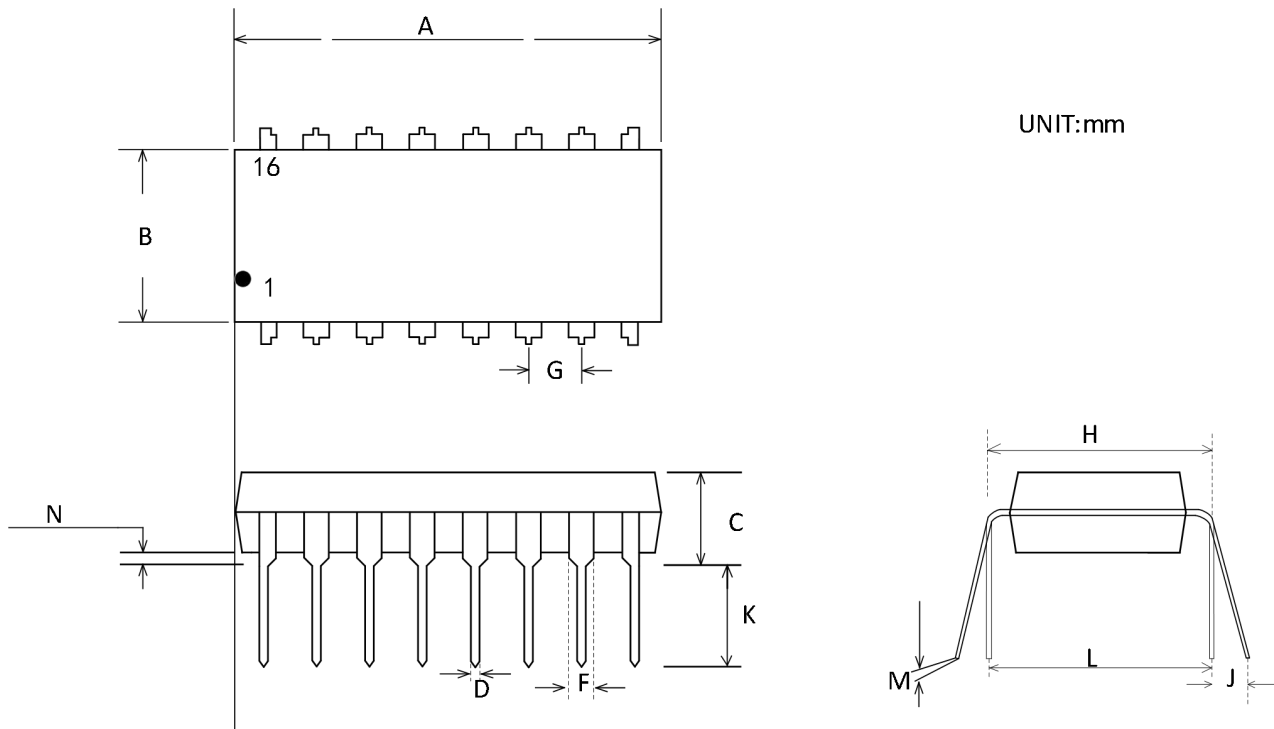


Figure 17. Use of Pullup Resistors to Increase Drive Current

## Package Information

### DIP-16

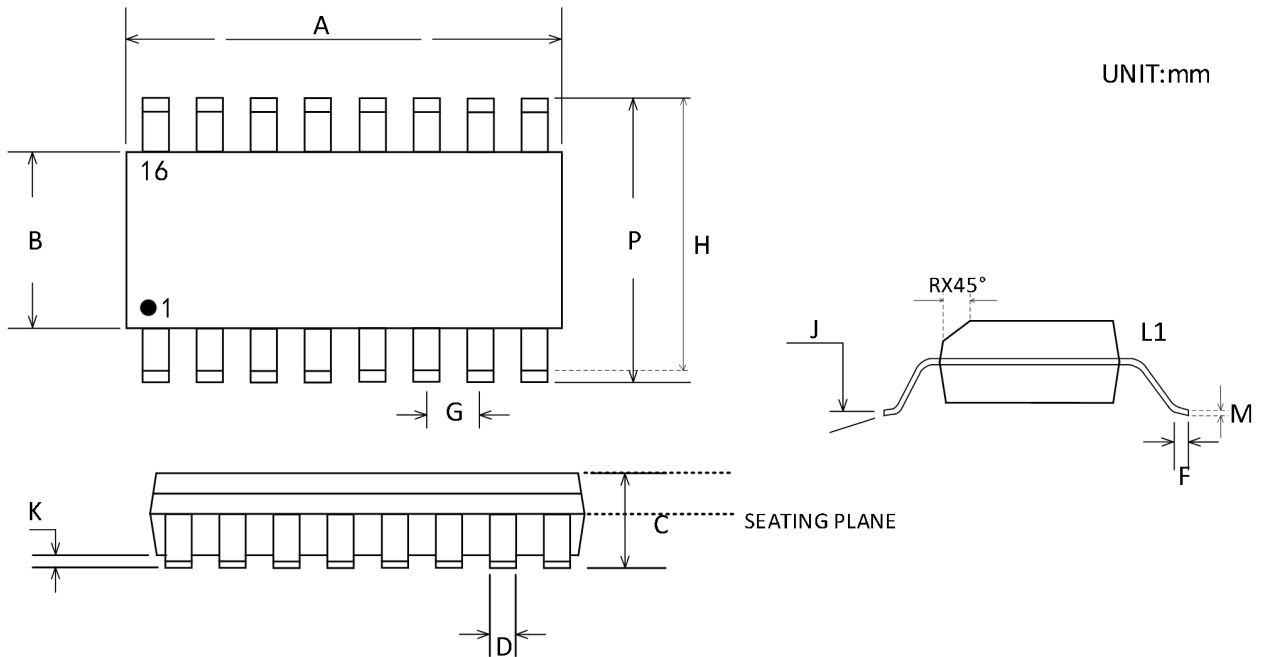


SYMBOL	MILLIMETER		SYMBOL	MILLIMETER	
	MIN	MAX		MIN	MAX
A	18.67	19.69	H	7.62	
B	6.10	7.11	J	0°	10°
C		5.33	K	2.92	3.81
D	0.36	0.56	L	7.62	8.26
F	1.14	1.78	M	0.20	0.36
G	2.54		N	0.38	

#### NOTES:

1. Dimensions "A" , "B" do not include mold flash or protrusions.
2. Maximum mold flash or protrusions 0.25 mm (0.010) per side.

## SOP-16

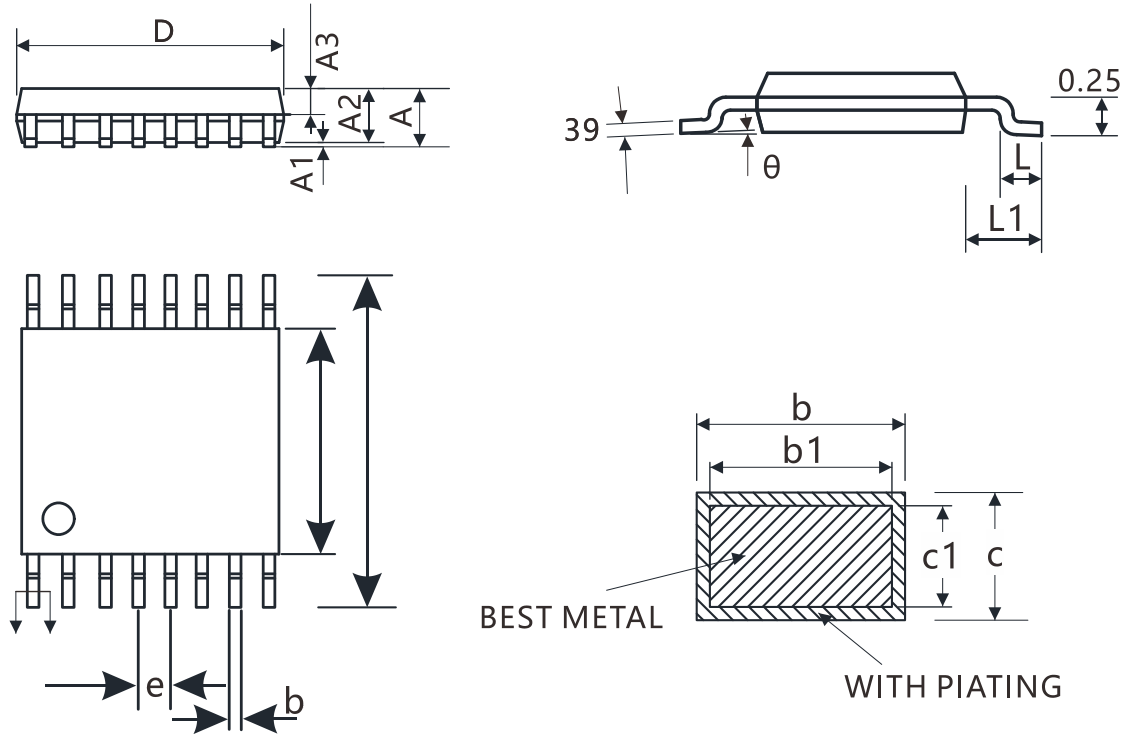


SYMBOL	MILLIMETER		SYMBOL	MILLIMETER	
	MIN	MAX		MIN	MAX
A	9.80	10.00	H	5.72	
B	3.80	4.00	J	0°	8°
C	1.35	1.75	K	0.10	0.25
D	0.33	0.51	M	0.19	0.25
F	0.40	1.27	P	5.80	6.20
G	1.27		R	0.25	0.50

### NOTES:

- Dimensions A and B do not include mold flash or protrusion.
- Maximum mold flash or protrusion 0.15 mm (0.006) per side for A; for B - 0.25 mm (0.010) per side.

## TSSOP-16



SYMBOL	MILLIMETER(MM)			SYMBOL	MILLIMETER(MM)		
	MIN	NOM	MAX		MIN	NOM	MAX
A			1.75	D	9.70	9.90	10.10
A1	0.10		0.25	E	5.80	6.00	6.20
A2	1.35	1.40	1.45	E1	3.70	3.90	4.10
A3	0.60	0.65	0.70	e	1.27 BSC		
b	0.39		0.48	L	0.50		0.80
b1	0.38	0.41	0.43	L1	1.05 BSC		
c	0.21		0.26	θ	0°		8°
c1	0.19	0.20	0.21				
L/F 载体尺寸 (mm)	75×75						
	90×110						
	70×180						

## Package/Ordering Information

ORDERING	TEMPRANGE	PACKAGE	MARK	TRANSPOT
CBM2004AS16	-40°C~85°C	SOP-16	CBM2004AS	Tape and Reel,2500
CBM2004AS16-RL	-40°C~85°C	SOP-16	CBM2004AS	Tape and Reel,3000
CBM2004AS16-REEL	-40°C~85°C	SOP-16	CBM2004AS	Tape and Reel,4000
CBM2004ATS16	-40°C~85°C	TSSOP-16	CBM2004AT	Tape and Reel,2500
CBM2004ATS16-RL	-40°C~85°C	TSSOP-16	CBM2004AT	Tape and Reel,3000
CBM2004ATS16-REEL	-40°C~85°C	TSSOP-16	CBM2004AT	Tape and Reel,4000
CBM2004ADP16	-40°C~85°C	DIP-16	CBM2004AD	Tube,2500